SMQ MELF PIN Diode

Features

- RoHS Compliant
- Rectangular MELF SMQ Ceramic Package
- Low Rs for Low Series Loss
- Long τ_{L} for Low Intermodulation Distortion
- Low Cj for High Series Isolation
- High Average Incident Power Handling

Description and Applications

The MA4P7418-10720T is a surface mount PIN diode in a Metal Electrode Leadless Faced (MELF) package. The device incorporates M/A-COM Technology Solutions time proven HIPAX technology to produce a low inductance ceramic package with no ribbons or whisker wires. Incorporated in the package is a fully passivated PIN diode chip that is full face bonded on both the cathode and anode to maximize the surface contact area for low electrical and thermal resistance. The MA4P7418-10720T has been comprehensively characterized both electrically and mechanically to ensure repeatable and predictable performance. The diode is well suited for use in low loss, low distortion, high power switching circuits. The low thermal resistance of this device provides excellent high average performance at RF power incident levels up to 200 watts CW. This device is designed to meet the most rigorous electrical and mechanical requirements.

1072 Full Face Chip Bond Passivated PIN Chip

Diode Cross Section

Designed for Automated Assembly

SMQ MELF PIN diodes are designed for high volume tape and reel assembly. The rectangular package design provides a highly efficient means for automatic pick and place assembly techniques. The parallel flat surfaces are suitable for key jaw or vacuum pickup techniques. All solderable surfaces are tin plated and compatible with reflow and vapor phase soldering methods.

Absolute Maximum Ratings¹@+25°C

Parameter	Absolute Maximum
Operating Temperature	-65°C to +125°C
Storage Temperature	-65°C to +200°C
Diode Junction Temperature	+175°C
Diode Mounting Temperature	+265°C for 10 seconds
C.W. Thermal Resistance (Θ jc) Using Infinite Heat Sink	13 °C/W
Power Dissipation @ +25°C De-rate linearly by to 0W @ +175C by -76.6 mW/°C Using Infinite Heat Sink	11.5 W
Forward D.C. Current	+150mA
Reverse D.C. Voltage	-1100V

1. Exceeding any of these limits may cause permanent damage.

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Rev. V4

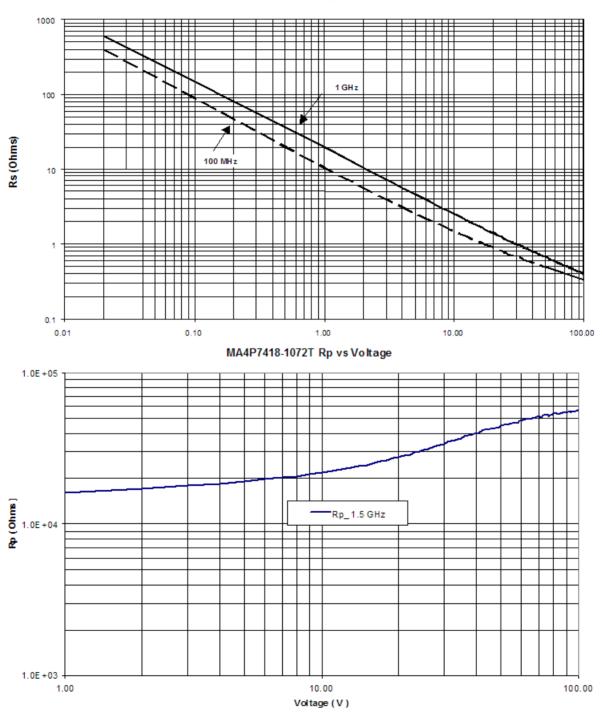
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Typical Electrical Performance @ +25°C



MA4P7418-1072T Rs vs I

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SMQ MELF PIN Diode

MA4P7418-1072T Ct vs Voltage 1 1500 MH z 4 Ct (pF) 100 MHz 0.1 0.1 10.0 1.0 100.0 Voltage (V) MA4P7418 -1072T Ls vs Frequency 1 × Ls_50 mA Ls (nH) 0.1 100.0 1000.0

Typical Electrical Performance @ +25°C

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Frequency (MHz)



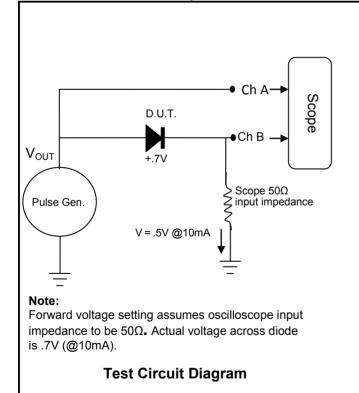
SMQ MELF PIN Diode

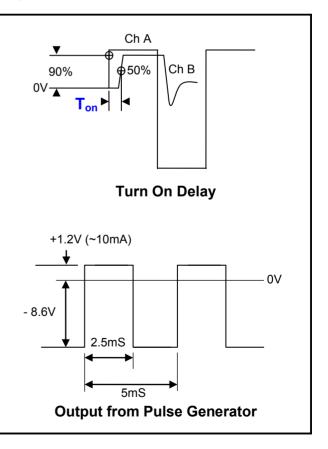
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Symphol		
Symbol	Condition	Unit Value
VF	I _F = +100mA	1.0 V _{DC}
V _R	Ir = -10μΑ	-1100 V _{DC}
Ст	-100V @ 100MHz	0.8pF
Rs	+100mA @ 100MHz	1.2 Ohms
R _P	-10V @ 100MHz	50K Ω
τι	+6mA / -10mA (50% - 90% Voltage)	7 µs
T _{ON}	50% Control Voltage - 90% Output Voltage	2.5 µS
μm	-	140 μm
θјс	I _H = 1A, I _L = 10mA, T = 1mS	13°C/W
W	I _F = +100mA	4W
PD	I _F = +100mA	11.5W
-	V _R C _T Rs R _P τ _L T _{ON} μm θjc W	V_R Ir = -10µA C_T -100V @ 100MHz R_S +100mA @ 100MHz R_P -10V @ 100MHz τ_L +6mA / -10mA (50% - 90% Voltage) T_{ON} 50% Control Voltage - 90% Output Voltage μ m - θ jc I_H = 1A, I_L = 10mA, T = 1mS W I_F = +100mA

1. V_R (Reverse Voltage) is sourced and the resultant reverse leakage current, Ir, is measured to be <10µA.

2. See below for turn on delay measurement





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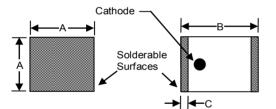
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Environmental Capability

MELF devices may be used in industrial or military applications and can be screened to meet the environmental requirements of MIL-STD-750, MIL-STD-202 as well as other military standards. The table below lists some of the MIL-STD 750 tests the device is designed to meet.

MIL-STD-750			
Test	Method	Description	
High Temperature Storage	1031	+150°C, for 340 Hours	
Temperature Shock	1051	-65°C to +125°C, 20 Cycles	
HTRB	1038	80% of rated V _B , +150 $^\circ$ C, for 96 Hours	
Moisture Resistance	1021	No Initial Conditioning, 85% RH, +85°C	
Gross Leak	1071 Cond. E	Dye Penetrant Visual	
Vibration Fatigue	2046	20,000 G's, 60 Hz, x, y, z axis	
Solderability	2026	Test Temperature = +245°C	

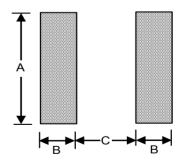
1072 MELF Surface Mount Package



Dimension	INC	HES	М	Μ
ion	MIN.	MAX.	MIN.	MAX.
А	0.080	0.095	2.032	2.413
В	0.115	0.135	2.921	3.429
С	0.008	0.030	0.203	0.762

Circuit Pad Layout for 1072 MELF

Dimension	inches	mm
A	0.093	2.36
В	0.050	1.27
С	0.060	1.52



Ordering Information

Part Number	Package	Quantity
MA4P7418-1072T	Tape and reel	1500ps

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